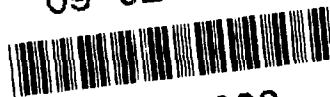


RECORDA

09-02-1999



101134633

S. DEPARTMENT OF COMMERCE  
Patent and Trademark Office

Attorney Docket No.: 041846-5027

To the Assistant Commissioner for Patents:  
Please record the attached original documents or copy thereof.

ATTN: BOX ASSIGNMENT

1. Name of conveying party(ies):

1. Tetsuo YAMADA
2. Kenji MITANI
3. Masaki UMEMOTO

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name: Stanley Electric Co., Ltd.

Internal Address:

3. Nature of conveyance:

- ☒ Assignment ☐ Merger  
☐ Security Agreement ☐ Change of Name  
☐ Other \_\_\_\_\_

Street Address: 2-9-13 Nakameguro, Meguro-ku, Tokyo  
153-8636 Japan

City:

State:

Zip:

Additional name(s) & address(es) attached?

☐ Yes ☒ No

Execution Date: August 23, 1999

4. Application number(s) or patent number(s):

09 383380

If this document is being filed together with a new application the execution date of the application is:  
August 23, 1999

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached: ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Mr. Robert J. Gaybrick

Internal Address: Morgan, Lewis & Bockius LLP  
Customer No. 09629

Street Address: 1800 M Street, N.W.  
City: Washington State: D.C. Zip: 20036

6. Total number of applications and patents involved: 1

7. Total fee (37 C.F.R. §3.41): \$40.00

☒ Enclosed

☐ Authorized to be charged to deposit account 50-0310

8. Deposit account number: 50-0310

Attach duplicate of page if paying by deposit account

9. Statement and Signature

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

J. Michael Thesz

Name of Person Signing

[Signature]  
Signature

August 26, 1999

Date

9/01/1999 MTHA11 00000315 09383380

Total number of pages including cover sheet, attachments and documents: 3

## ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:  
for which I/WE executed an application for United States Letters Patent concurrently herewith; or on \_\_\_\_\_; or filed  
an application for United States Letters Patent on \_\_\_\_\_, (Serial No. \_\_\_\_\_); and

WHEREAS, STANLEY ELECTRIC CO., LTD., a corporation of JAPAN, whose post office address is 2-9-13  
Nakameguro, Meguro-ku, Tokyo 153-8636 Japan (hereinafter referred to as Assignee), is desirous of securing the entire right, title,  
and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters  
Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other  
good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold,  
assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and  
assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations  
thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim  
priority on the basis of such application, and all applications for Letters Patent which may hereafter be filed for this invention in  
any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions,  
renewals, and reissues thereof; and I/WE hereby authorize and request the Commissioners of Patents and Trademarks of the United  
States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters  
Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/WE have the full right to convey the interest assigned by this Assignment, and  
I/WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with  
assignee, its successors and assigns, any facts known to ME/US respecting this invention, and testify in any legal proceeding, sign  
all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the  
title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make  
all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent  
protection for this invention in the United States and any foreign country, it being understood that any expense incident to the  
execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney  
in this application, to insert here in parentheses (Application No. \_\_\_\_\_, filed \_\_\_\_\_) the filing date  
and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Country of <u>Japan</u>	<u>Tetsuo YAMADA</u> Full Name of Sole or First Assignor
States of _____	<u>1-22-60-10, Taru-machi, Kouhoku-ku</u> <u>Yokohama-shi, Kanagawa, 222-0001, Japan</u> Address
Subscribed and sworn to before me This ____ day of _____, 19____	<u>Tetsuo Yamada</u> First Assignor's Signature
_____ Notary Public	<u>Aug. 23, 1999</u> Date
Names of additional inventors attached [ X ] Yes [ ] No	

Morgan Lewis & Bockius LLP

Country of Japan

States of \_\_\_\_\_

Subscribed and sworn to before me

This \_\_\_ day of \_\_\_\_\_, 19\_\_\_

\_\_\_\_\_, Notary Public

SS.

Kenji MITANI

Full Name of Second Assignor

2-5-1-718 Deiki, Kanazawa-ku, Yokohama-shi

Kanagawa, 236-0021, Japan

Address

Kenji Mitani  
Second Assignor's Signature

Aug 23, 1999  
Date

Country of Japan

States of \_\_\_\_\_

Subscribed and sworn to before me

This \_\_\_ day of \_\_\_\_\_, 19\_\_\_

\_\_\_\_\_, Notary Public

SS.

Masaki UMEMOTO

Full Name of Third Assignor

5-8-13 Ikou, Adachi-ku, Tokyo, 121-0823, Japan

Address

Masaki Umemoto  
Third Assignor's Signature

Aug 23, 1999  
Date

Names of additional inventors attached [ ] Yes [X] No